

# 2SK1836, 2SK1837

Silicon N-Channel MOS FET

**HITACHI**

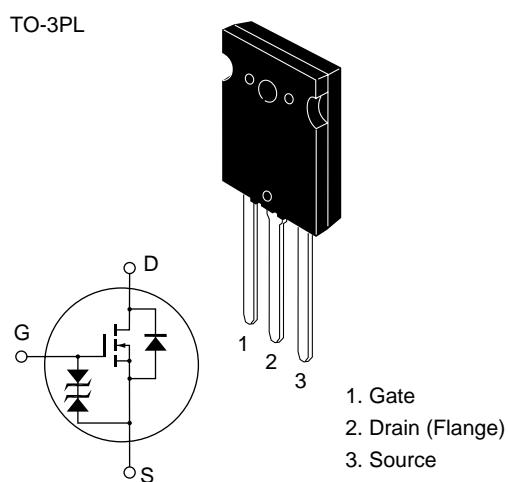
## Application

High speed power switching

## Features

- Low on-resistance
- High speed switching
- Low drive current
- No secondary breakdown
- Suitable for switchingregulator, DC-DC converter

## Outline



## **2SK1836, 2SK1837**

### **Absolute Maximum Ratings (Ta = 25°C)**

Item		Symbol	Ratings	Unit
Drain to source voltage	K1836	V <sub>DSS</sub>	450	V
	K1837		500	
Gate to source voltage		V <sub>GSS</sub>	±30	V
Drain current		I <sub>D</sub>	50	A
Drain peak current		I <sub>D(pulse)</sub> <sup>*1</sup>	200	A
Body to drain diode reverse drain current		I <sub>DR</sub>	50	A
Channel dissipation		Pch <sup>*2</sup>	250	W
Channel temperature		T <sub>ch</sub>	150	°C
Storage temperature		T <sub>stg</sub>	-55 to +150	°C

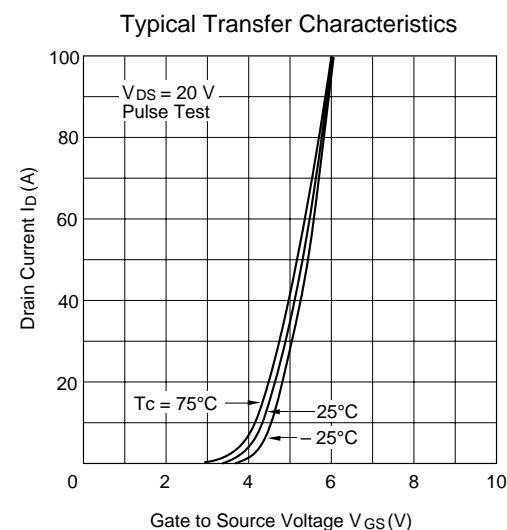
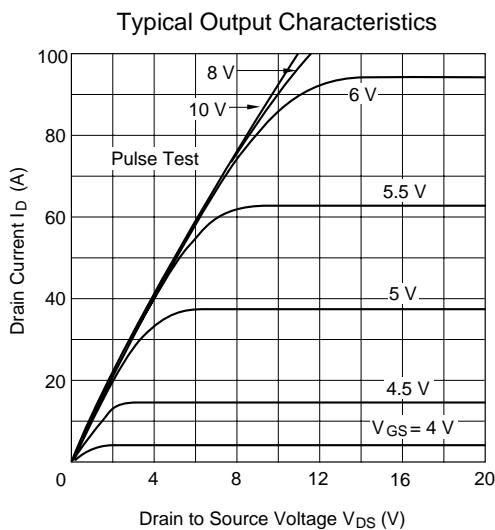
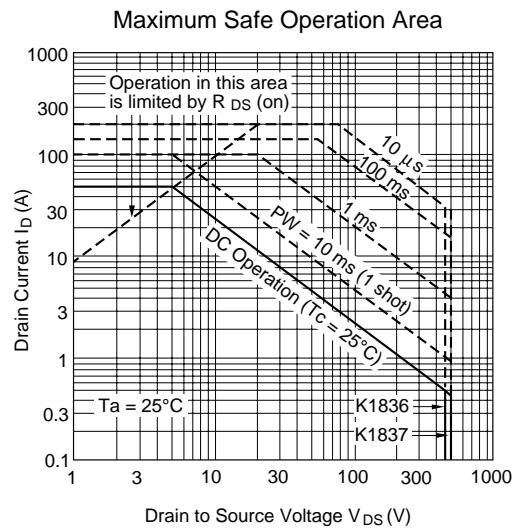
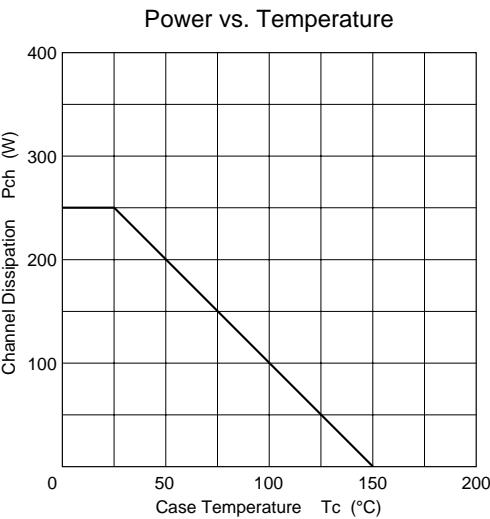
Notes 1. PW 10 µs, duty cycle 1 %

2. Value at T<sub>c</sub> = 25 °C

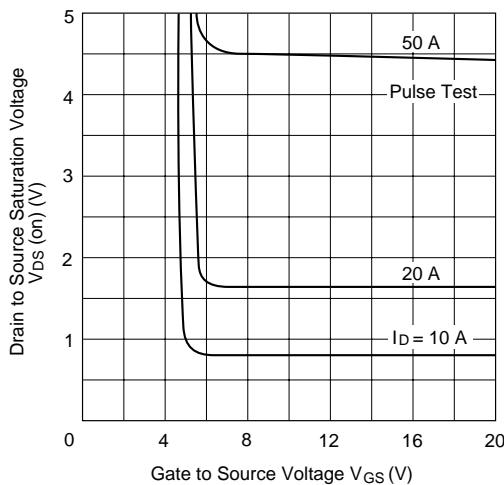
## Electrical Characteristics (Ta = 25°C)

Item		Symbol	Min	Typ	Max	Unit	Test conditions
Drain to source breakdown voltage	K1836 K1837	V <sub>(BR)DSS</sub>	450 500	— —	— —	V	I <sub>D</sub> = 10 mA, V <sub>GS</sub> = 0
Gate to source breakdown voltage		V <sub>(BR)GSS</sub>	±30	—	—	V	I <sub>G</sub> = ±100 µA, V <sub>DS</sub> = 0
Gate to source leak current		I <sub>GSS</sub>	—	—	±10	µA	V <sub>GS</sub> = ±25 V, V <sub>DS</sub> = 0
Zero gate voltage drain current	K1836 K1837	I <sub>DSS</sub>	—	—	250	µA	V <sub>DS</sub> = 360 V, V <sub>GS</sub> = 0 V <sub>DS</sub> = 400 V, V <sub>GS</sub> = 0
Gate to source cutoff voltage		V <sub>GS(off)</sub>	2.0	—	3.0	V	I <sub>D</sub> = 1 mA, V <sub>DS</sub> = 10 V
Static drain to source on state resistance	K1836 K1837	R <sub>DS(on)</sub>	—	0.08 0.085	0.10 0.11	pF	I <sub>D</sub> = 25 A V <sub>GS</sub> = 10 V* <sup>1</sup>
Forward transfer admittance		y <sub>fs</sub>	22	35	—	S	I <sub>D</sub> = 25 A V <sub>DS</sub> = 10 V* <sup>1</sup>
Input capacitance		C <sub>iss</sub>	—	8150	—	pF	V <sub>DS</sub> = 10 V
Output capacitance		C <sub>oss</sub>	—	2100	—	pF	V <sub>GS</sub> = 0
Reverse transfer capacitance		C <sub>rss</sub>	—	180	—	pF	f = 1 MHz
Turn-on delay time		t <sub>d(on)</sub>	—	80	—	ns	I <sub>D</sub> = 25 A
Rise time		t <sub>r</sub>	—	250	—	ns	V <sub>GS</sub> = 10 V
Turn-off delay time		t <sub>d(off)</sub>	—	550	—	ns	R <sub>L</sub> = 1.2
Fall time		t <sub>f</sub>	—	220	—	ns	
Body to drain diode forward voltage		V <sub>DF</sub>	—	1.1	—	V	I <sub>F</sub> = 50 A, V <sub>GS</sub> = 0
Body to drain diode reverse recovery time		t <sub>rr</sub>	—	620	—	ns	I <sub>F</sub> = 50 A, V <sub>GS</sub> = 0, di <sub>F</sub> / dt = 100 A / µs

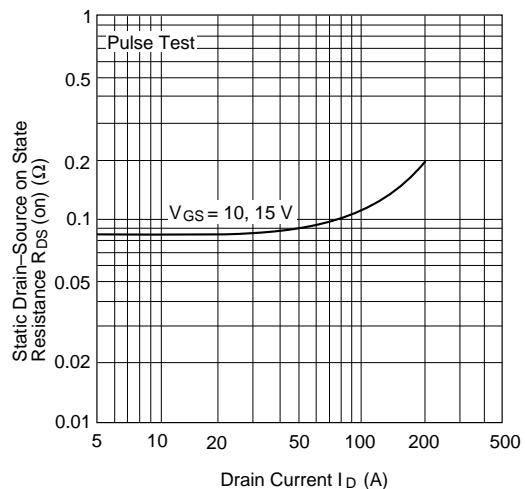
Note 1. Pulse Test



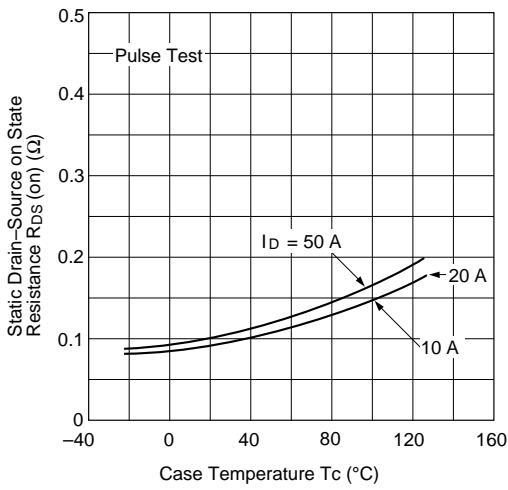
Drain to Source Saturation Voltage  
vs. Gate to Source Voltage



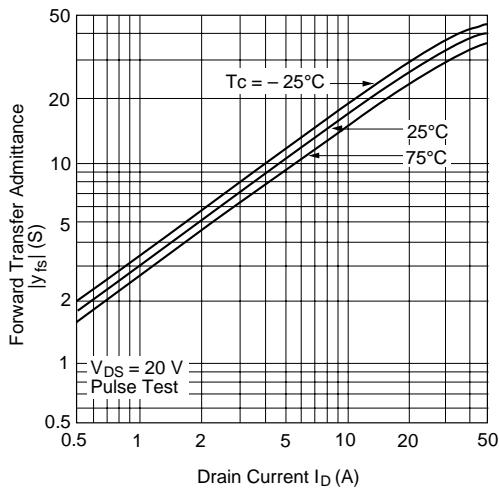
Static Drain to Source on State  
Resistance vs. Drain Current

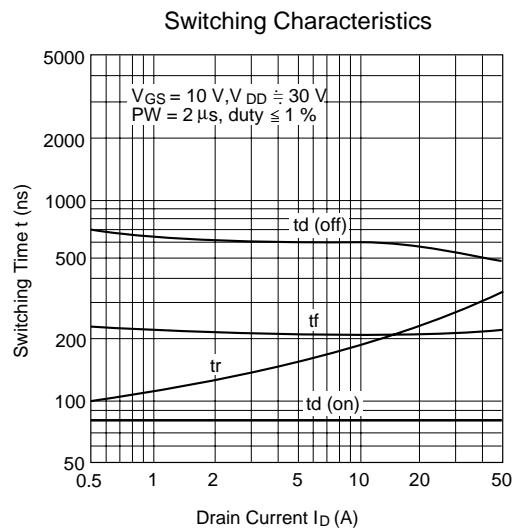
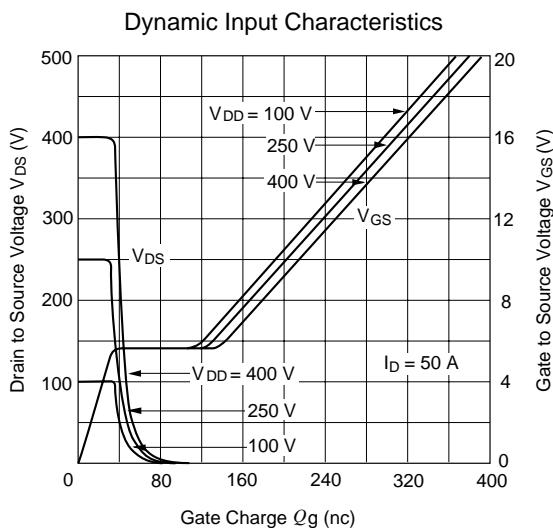
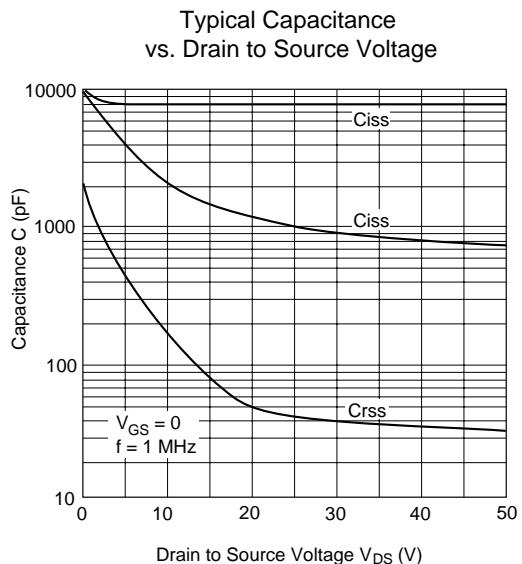
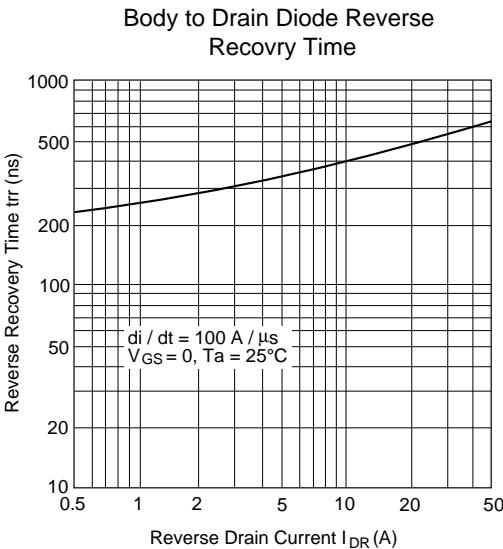


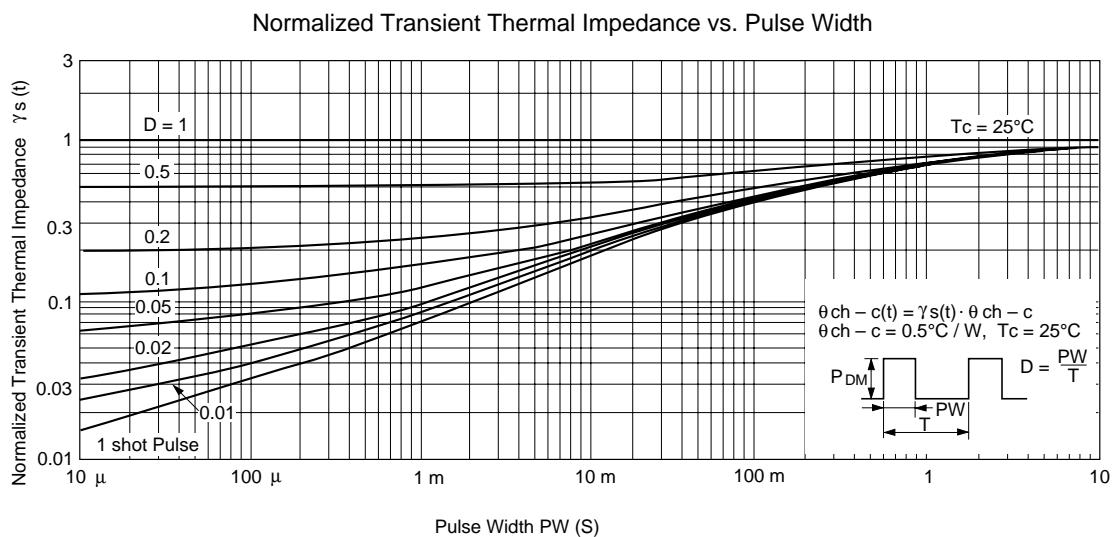
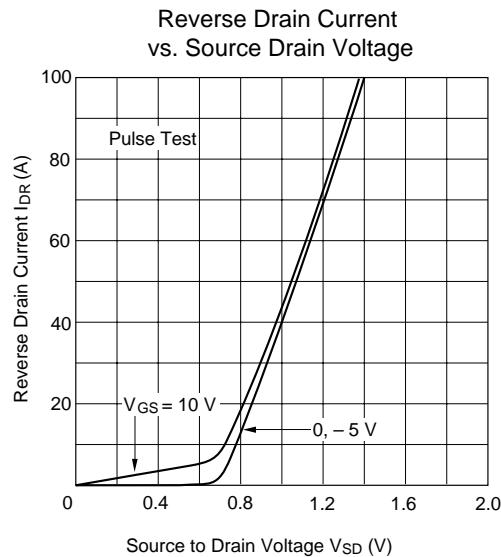
Static Drain to Source on State  
Resistance vs. Temperature



Forward Transfer Admittance  
vs. Drain Current

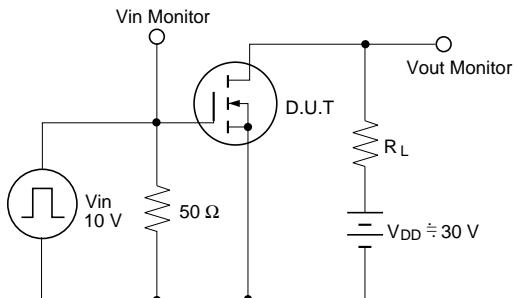




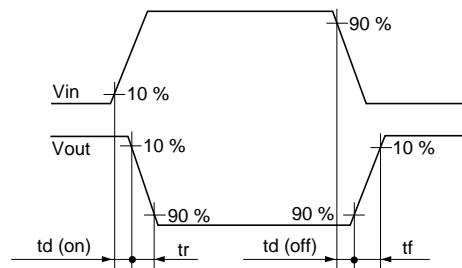


## **2SK1836, 2SK1837**

Switching Time Test Circuit



Waveforms



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